

# CXN5001 product label

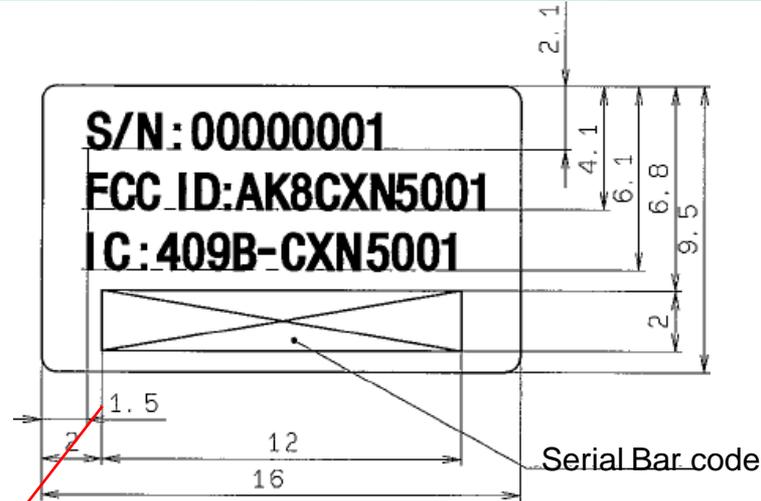
Aug 6, 2009

SONY corp.  
Semiconductor business group  
HSS div. Information device dept.

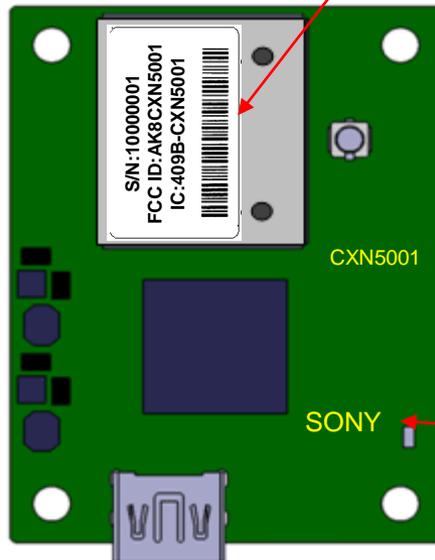
# The Image for installation of CXN5001 Module

Label Specification  
 Top of the Shield case :

**Label Material: polyester**  
**Binding material: acrylic**  
**Thickness: 50um**



Bar code size : 2 x 12mm  
 Letter height : 1.2 mm



Model name

Sony logo